Appl. No.: 10/606,508 > Response Dated: 01/17/2006

Reply to Office Action of: 10/17/2005

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No.

10/606,508

Applicant

James J. Bernas, et al.

Filed

6/26/03

Title

Double-Skin Honeycomb Substrate and

Extrusion Die Assembly for Making the Same

TC/A.U.

:

Examiner

Ling X. Xu

1775

Docket No.

SP03-073

CERTIFICATE OF MAILING (37 CFR 1.8a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an

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22313-1450 on: 1/17/06

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Mail Stop Amendment Commissioner for Patents P.O. Box 1450

Alexandria, VA 22313-1450

AMENDMENT

Sir:

In response to the Office communication mailed on 10/17/2005, please amend the above-identified as follows:

Amendments to the Specification - page 2 following;

Amendments to the Claims – page 3 following;

Remarks/Arguments - page 6 following.